CMOS 4-BIT MICROCONTROLLER

TMP47C858F

The 47C858 is a high performance 4-bit single chip microcomputer based on the TLCS-470 series. The 47C858 has plentiful operating modes (SLOW, SLEEP, HOLD) intended to save the power, with LCD driver and DTMF generator which are highly suitable for application in telephones.

PART No.	ROM	RAM	PACKAGE	PIGGYBACK
TMP47C858F	8192 × 8-bit	512 x 4-bit	QFP100	TMP47C058G

FEATURES

- ♦4-bit signal chip mocrocomputer
- ♦Instruction execution time:

8.3µs (at 960KHz), 244µs (at 32.8KHz)

- ◆Low voltage operation: 2.7V min.
- ♦92 basic instrutions
- **◆**Table look-up instructions
- ◆Subroutine nesting: 15 levels max.
- ◆6 interrupt sources (External: 2, Internal: 4)

 All sources have independent latchs each, and multiple interrupt control is available.
- ♦1/O port (36pins)
 - Input 2ports 5pins
 - 1/O 8ports 31pins
- ♦Interval Timer (22 stages)
- ◆Two 12-bit Timer/Counters

Timer, event counter, and pulse width measurement mode

◆Serial Interface with 8-bit buffer

External/internal clock, and leading/trailing edge shift, and 4/8-bit mode

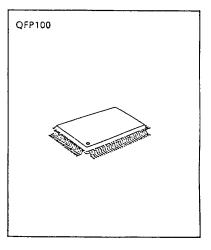
♦LCD driver

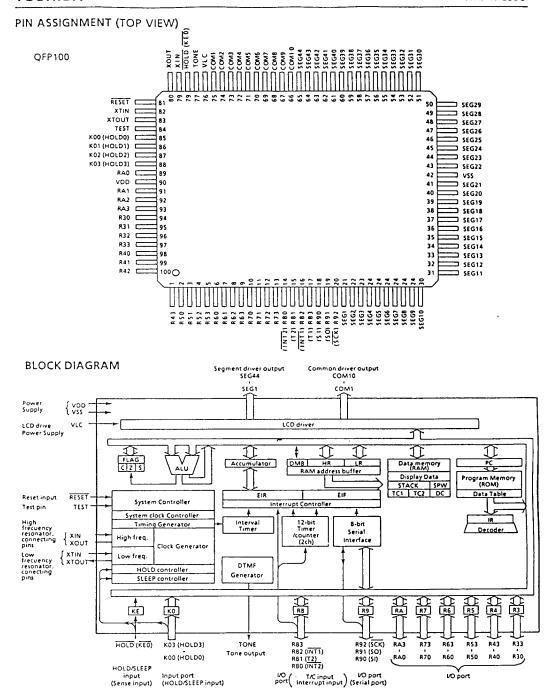
LCD direct drive is available (440 dots display, 1/10 duty)

- ◆DTMF (Dual Tone Multi Frequency) output
 - DTMF output with one instrution
 - · Single tone output function
- ◆Dual-clock operation

High-speed/Low-power-consumption operating mode

- **♦**HOLD function
 - Battery/Capacitor back-up
- **♦** SLEEP function
 - Battery/Capacitor back-up
 - LCD is displaying





4-224

PIN FUNCTION

PIN NAME	Input/Output	FUNC	TIONS
K03 (HOLD3) , K00 (HOLD0)	Input (Input)	4-bit input port	HOLD and SLEEP request/release signal input (Active "H")
R33 - R30			J.,
R43 - R40		4-bit I/O port with latch.	
R53 - R50	1/0	When used as input port, the latch must be	e set to "1".
R63 - R60	2		
R73 - R70			
R83 (T1)			Timer/Counter 1 external input
R82 (ĪNT1)	I/O (Input)	4-bit I/O port with latch. When used as input port, external	External interrupt 1 input
R81 (T2)	#O (mpat)	interrupt input pin, or Timer/counter external input pin, the latch must be set	Timer/Counter 2 external input
R80 (ĪNT2)		to "1".	External interrupt 2 input
R92 (ŠČK)	1/0 (1/0)	3-bit I/O port with latch.	Serial clock I/O
R91 (SO)	I/O (Output)	When used as input port or serial port, the latch must be set to "1".	Serial data output
R90 (SI)	VO (Input)	die interimon de secto	Serial data input
RA3 - RAO	vo	4-bit I/O port with latch. When used as input port, the latch must be	e set to "1".
SEG44 - SEG1		LCD segment driver output	
COM10 - COM1	Output	LCD common driver output	
TONE	Output	Tone output	***************************************
XIN	Input	Resonator connecting pins (High frequenc	v) .
XOUT	Output	For inputting external clock, XIN is used an	• •
XTIN	Input	Oscillator connecting pins (Low frequency)).
хтоит	Output	For inputting external clock, XTIN is used a	
RESET	Input	Reset signal input	
HOLD (KEO)	Input (Input)	HOLD and SLEEP request/release signal input	Sense input
TEST	Input	Test pin for out-going test. Be opened or fix	red to low level.
VDD		+ 2.7V to 6.0V	
vss	Power Supply	OV (GND)	
VLC		LCD drive power supply	

OPERATIONAL DESCRIPTION

Concerning the 47C858 the configuration and functions of hardwares are described. As the description has been provided with priority on those parts differing from the 47C800, the technical data sheets for the 47C800 shall also be referred to.

SYSTEM CONFIGURATION

(1) CPU Core functions

Except for the systemcontrol circuit, the CPU core functions are the same as those of the 470800.

- (2) Periferal Hardware Functions
 - ① I/O Ports

(5) LCD Driver

② Interval Timer ③ Timer/Counter

- ⑤ DTHF Generator
 ⑦ Serial Interface
- (4) One-second Signal Detection Circuit

The following are explanations of functions ① and ④—⑥ which have been added to the 47C858 or which are different from those of the 47C800, and the system clock control circuit.

2 CPU CORE FUNCTIONS

2. 1 SYSTEM CONTROL CIRCUIT

It is possible to shift from the SLOW operating mode to the SLEEP operating mode to further reduce power consumption: and still maintain the internal status. In the SLEEP mode, all operations execpt for the timing generator(TG) binary counter and LCD driver are suspended.

2.1.1 System Clock Controller

The system clock controller starts or stops the high-frequency and low-frequency clock oscillator and switches between the basic clocks. The operating mode is generally divided into the single-clock mode and the dual-clock mode, which are controlled by command.

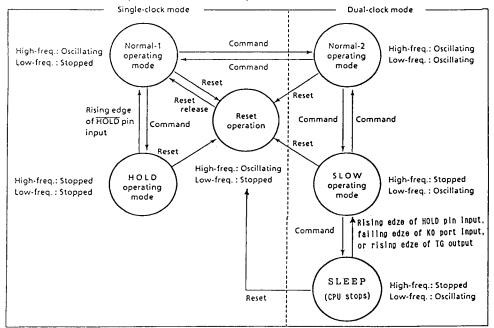


Figure 2-1 Operating Mode Transition Diagram

(1) Control of System Clock

System clock control

The system clock is controlled by the command register (OP16). Dureing a reset, the command register is reset to "O" and the single clock mode is selected. Oscillation of the low-frequency clock is started in the single clock mode by setting bit 3 of OP13.

Low-frequency oscillation control

(Port address: OP13 Initial value: 000+)

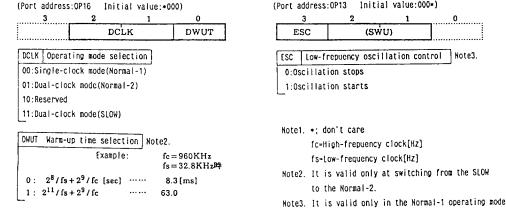


Figure 2-2. System Clock Control Command Register

2.1.2 Operating Mode

There are two operating modes: the Single-clock mode and the Dual-clock mode.

Single-clock Hode

Canceling a reset starts the Normal-1 operating mode. Oscillation of the low-frequency clock can be started and stopped in this mode. To shift to the Dual-clock mode, start oscillation with the low-frequency oscillation control command register (OP13) and then switch to the Norma-2 operating mode with the system clock control command register (OP16).

There is also a HOLD operating mode used for low power consumption operation. To switch to HOLD operation, stop oscillation of the low-frequency clock(OP13) and then switch with the HOLD operation mode command register(OP10).

(2) Dual-clock Hode

In the Dual-clock mode, the instruction cycle is normally generated with the high-frequency clock(fc) and then the Normal-2 operating mode is used. When necessary, the SLOW operating mode can be used by generating the low-frequency clock(fs). In addition, the SLEEP operation mode, in which all operations except the low-frequency clock and LCD driver are suspended, can also be used. Switching between Normal-2 operation, SLOW operation and SLEEP operation in the Dual-clock mode is explained below. During a reset, the command register is initialized to the Single-clock mode. At this time, the low-frequency clock is not being oscillated; therefore, start oscillation of the lowfrequency clock first and then switch to Normal-2 operation in the Dual-clock mode.

a) Switching from the Normal-2 operation to the SLOW operation

Setting DCLK(bit2 of OP16) to "1" switches to SLOW operation, but several seconds are required for lowfrequency clock oscillation to stabilize. Consequently, when there is a possibility of switching to SLOW operation immediately after shifting to Normal-2 operation, it is necessary to wait until oscillation of the low-frequency clock stabilizes. Oscillation of the high-frequency clock will stop at this time.

b) Returning from the SLOW operation to the Normal-2 operation

When DCLK(bit 2 of OP16) is cleared to "O", the warm-up time for resetting to DWUT(bit 0 of of OP16) is set at the same time. Normal-2 operation starts after the set warm-up time has elapsed.

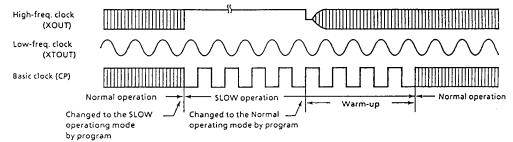


Figure 2-3. System Clock Swithing Timing

c)Shifting from the SLOW operation to the SLEEP operation

After selecting the return conditions using the return conditions selection register(OP13), shift to SLEEP operation (refer to the SLEEP operation mode explanation) by setting the command in the command register(OP10). Occurrence of the selected condition returns to SLOW operation.

Note1. The command register(OP10) is used for both HOLD operation control and SLEEP operation control. This register is used for HOLD operation control when accessed during Normal-1 operation and for SLEEP operation control when accessed during SLOW operation.

Note2. During SLOW operation and SLEEP operation, oscillation of the high-frequency clock is automatically halted to enable low power supply voltage operation and low power consumption operation. However, while less power is consumed by the oscillator and internal hardwaer, the amount of power consumed by the pin interface (dependent on external circuitry and programs) is not directly related to the low power consumption operation mode; therefore, caution is required during system design and interface circuit design. Also, the execution of instructions is not interrupted by switching to SLOW operation but, in some cases, there is influence on some of the peripheral hardwaer functions: therefore, refer to the explanations of the various operations.

2.1.3 HOLD Operation Hode

HOLD operation suspends system operation and holds the internal status immediately before the suspension with

HOLD operating mode control
(Port address:OP10 | Initial value:•0••)
3 2 1 0

HLDMS | HWUT

	HLDMS	HWUT
ALONS.	I Hode select/HOL	D operation start

01: Starts HOLD operation in edze sensitive release mode 11: Starts HOLD operation in level sesitive release mode

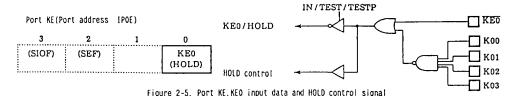
*0: Reserved

Note1. *; don't care

Note2. Do not access command register OP10 unless the HOLD operation mode is being used

Figure 2-4. Command Register

low power consumption. This mode is started by setting the command in the command register(OP10) in the Normal-1 operation mode, but it is necessary to stop the low-frequency clock(by clearing bit 3 of OP13) before accessing OP10. Hold control is possible not only from the HOLD pin but from the KO port as well. Figure 2-5 shows the relationship between the KE port, KEO input data and the HOLD control signal. The KE port is assigned to the lowest bit of port address IPOE and is read as the result of the logical operation of the KEO pin and KO pin input. When the KEO pin is "L" and all four KO pins are "H", for example, the KEO input data is read as "1". "O" is read at all other times.



The HOLD operation mode is released when a hold control signal rise from "0" to "1" is sensed. Consequently, if the hook switch is connected to the HOLD pin and the key switch is connected to the KO pin, it is possible to release HOLD operation by either turning off the hook switch or by pressing a key. Thus, an on-hook dialing function can easily be implemented. Other than that, the HOLD operation mode is the same as for the 47C800. For details, refer to the 47C800 technical data.

2.1.4 SLEEP operation mode

The SLEEP operation mode suspends all SLOW operation operations except for the low-frequency clock, TG binary counter and LCD driver, and retains the internal status with low power consumption without stopping the clock function and LCD display.

SLEEP mode control Return conditions selection register (Port address : OP13 Initial value : 000*) (Port address: OP10 Initial value: ****) 3 SLPMS (ESC) SŴU SLPHS | Hode selection and SLEEP operation starts SWU Return conditions selection 0111: Starts SLEEP operation in edge sensitive release mode 00: HOLD and KO pin input 10: HOLD, KO pin and 1 sec signal 1111: Starts SLEEP operation in level sensitive release mode *1: HOLD, KO pin and 15.625msec signal The other codes are reserved

Figure 2-6. Command Register, Return Conditions Selection register.

Operation in the edge relese mode and level release mode is the same as in the HOLD operation mode. To start SLEEP operation, select the return conditions during SLOW operation with the return conditions selection register(OP13) and then set the start command in the command register(OP10). SLEEP operation is then return to SLOW operation when the conditions selected with the return conditions selection register occur.

Example: Starting SLEEP operation using the HOLD and KO pin input, and the 1 sec signal as return condition.

A. #0CH : Selects HOLD, KO pin input and 1 sec signal LD OUT A, %OP13 LD A. #7H : Starts SLEEP operation OUT A, %OP10 KO pin input 1 sec signal SLOW Operation mode SLEEP Starts SLEEP operation

Figure 2-7 Return Conditions and operation Hode

3. PERIPHERAL HARDWARE FUNCTION

3.1 I/O Ports

The 47C452A has 10 ports (36 pins) each as follows:

- Ф ко
- R4, R5, R6
- 3 R3, R7, RA
- Ø R8

6 KE

S R9

Table 3-1 lists the port address assignments and the I/O instructions that can access the ports.

(1) Port K0 (K03-K00)

Port K0 (Port address IP00)

The 4-bit input port with pull-up resistors, shared by hold request/release signal input.

3 2 1 0 K03 K02 K01 K00 (HOLD3) (HOLD1) (HOLD0)

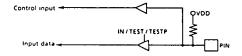
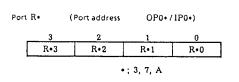


Figure 3-1. Port K0

(2) R3 (R33~R30), R7 (R73~R70), RA (RA3~RA0)

The 4-bit I/O port with latch. When used as an input port, the latch must be set to "1". The latch is initialized to "1" during reset.



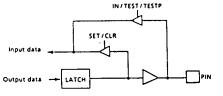


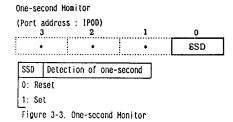
Figure 3-2. R3, R7, RA

3.2 One-second Signal Detection Circuit

A one-second signal detection circuit is built-in to enable clock functions. A flip-flop construction is used which is set by the rise (one second) of the TG final stage output and which is reset by accessing port address OPOD. The one-second detection circuit can be used in Normal-2 operation, SLOW operation and SLEEP operation mode.

Example 1. Reads F/F
IN %IPOD, A

[xample 2. Resets F/F
OUT A, %OPOD



10 10 10 10 10 10 10 10	Port	ď	Port			Judul	Input/Output instructions	ions		
Now register Now register Column register Colum register Column register Column register Column register	Address (••)		Output (OP**)	IN %p, A CIN %p, @HLC	UT A,%p UT @HL,%p	OUT #k,%p	OUTB @HL			SET @L CLR @L
Column register Row register Column register Column register Risoulput port Ris	00H	K0 input port		0		-	1	,	0	
Rainput port Rain		COLUMN register	KOW register	00	00	00			00	ı
Rainput port Ra output port Ra output port Ra input port Ra output port Ra outp		R3 input port	R3 output port) C) () (D) () (ı
Residuct port Residunt por		R4 input port	R4 output port	0) C		! !) (- -	ı (
Rightout port Rightout Rightout		R5 input port	R5 output port	0	00) C	I 1) C) () (
Raymout port Rayoutbut port Rayoutbut port Raymout port		R6 input port	R6 output por:	0	0) C	i) C) C) C
Restrict port Resolution port Restrict Restrict		R7 input port	R7 output port	0	0	0	ı	-)C) C) C
Residency port Reserts Fr C C C C C C C C C		R8 input port	R8 output port	0	C	C	ı) C)
RAinput port RA output port O		R9 input port	R9 output port	0	00	C	1	—) C) (<u></u>
1 Sec signal status status status Secial receive buffer Undefined Secial interface control 1		RAinput port	RA output port	0) C) C	1) C) (
1 Sec signal status	0.03	1) [))))	 I
1 sec signal status Resets F/F	2		-			1	l	1	ı	 I
Serial receive buffer Serial transmit buffer O	00	_	Resers F/F	С	· C	ı (i	ı	ı	i
Serial receive buffer Serial transmit buffer O	_	status))	1	ı	· (i
Undefined Hold operating mode control — — — Undefined Single tone control — — — — Undefined System clock control — — — — Undefined System clock control — — — — Undefined Undefined — — — — Undefined LCD driver control — — — — Undefined LCD driver control — — — — Undefined Timer/Counter 1 control — — — — Undefined Timer/Counter 2 control — — — — Undefined Serial interface control — — — —	0F		Serial transmit buffer	00	- C	ı C	1 1	1 1)	t
Undefined Single tone control	10н	Undefined	Hold operating mode control		C				1 1	
Undefined Single tone control	11	Undefined		1)	Į		1		ı
Undefined Slow clock/SLEP operation control —	12	Undefined	Single tone control	ı	0	ı	· I		ı i	1 1
Undefined	13	Undefined	Slow clock/SLEEP operation control	1	0	ı	ı	ı	ı	i
Undefined System clock control	14	Undefined	-	1	1	i	ı	ı	-	. 1
Undefined System clock control — — Undefined — — — Undefined — — — Undefined Interval Timer interrupt control — — Undefined Timer/Counter I control — — Undefined Timer/Counter I control — — Undefined Timer/Counter I control — — Undefined Serial interface control — — Undefined Serial interface control — —	15	Undefined		1	1	1	l			1
Undefined	16	Undelined	System clock control	1	С	ı	ı	ı	1	: 1
Undefined .	17	Undefined		ı)		1	1		l
Undefined Interval Timer interrupt control —	18	Undefined		ı			1	I	ı	ı
Undefined LCD driver control 2	19	Undefined	Josephal Timer interrupt control		· C	1		l	ı	1
Undefined LCD driver control 2	1A	Undefined)	l	ı	 I	l	I
Undefined Timer/Counter 1 control Undefined Timer/Counter 2 control Undefined Serial interface control Serial interface control —	1B	Undefined	1CD driver control 2		1 (ı	ı	ì	I
Undefined Timer/Counter 2 control Undefined Serial interface control Serial interface control	2	Undefined	Timer/Counter 1 control) C	ı	ı	. <u></u>	ı	I
Undefined Serial interface control 1 - O	11	Undefined	Timer/Counter 2 control	1) C	I I	1 1	1 1		l I
Undefined Serial interface control 2	1E	Undefined	Serial interface control 1	1	00	ı	1	- I	· I	· I
	1F	Undefined	Serial interface control 2	1	00	ı	ı	1	1	ı

The 5-bit to 8-bit data conversion instruction [OUTB @HU], automatic access to ROW register and Column register. "---" means the reserved state. Unavailable for the user program. Note 2. Note 1.

Table 3-1. Port Address Assignments and Available I/O Instructions

3.3 DTMF Generator

The 47C858 has a built-in DTMF generator which generates dialing signals for tone dialing type telephones. There are two groups of tone dial signals, one group of 4 sine wave low frequencies and another group of 4 sine wave high frequencies. All of these frequencies can be selected individually and combined with a frequency from the other group for a total of 16 different DTMF composite waves.

(DTMF; Dual Tone Multi Frequency)

3.3.1 Configuration of DTMF Generator

Figure 3-4 shows configuration of the DTMF generator. The 470858—generates two stepped, quasi sine waves for tone dial signals which can be combined and output. The high or low group of frequencies is selected by setting frequency selection codes into the ROW and COLUMN registers.

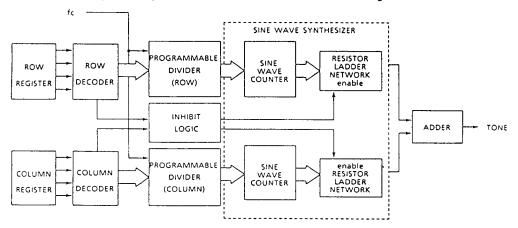


Figure 3-4. Configuration of DTMF Generator

3.3.2 Control of DTMF Generator

Tone output is controlled by ROW register (OP01/IP01) and COLUMN register (OP02/IP02). And single tone is controlled by TONE command register (OP12). ROW register, COLUMN register and TONE command register are initialized to "0" during the reset.

TONE command register (Port address OP12)

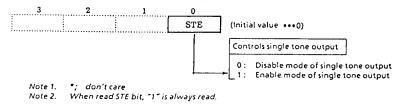


Figure 3-5. TONE command register

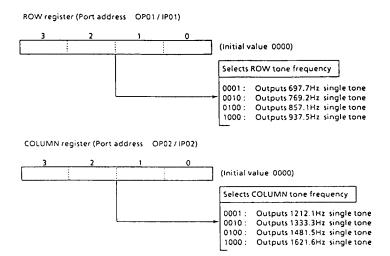


Figure 3-6. ROW, COLUMN Register

Tones are outputted by loading the frequency selection codes shown in Figure 3-6 into the ROW and COLUMN registers. In the enable mode of single tone output and either ROW or COLUMN register is disabled, another register remains to be enabled, and so single tone can be outputted, by loading an ineffective code into the register. When both the registers are enabled, dual tone can be outputted. In the disable mode of single tone output, effective codes are loaded into both ROW and COLUMN registers and then dual tone can be outputted. At this time, an ineffective code is loaded into ROW or COLUMN register and then the 47C858 has no tone output signal.

The [OUTB @HL] instruction can set 8-bit data into both registers (the upper 4 bits of the ROM data go to the COLUMN register and the lower 4 bits go to the ROW register) at the same time, and DTMF signal is outputted without single tone output.

Example 1: To output 1481.5Hz single tone

OUT #8,%0P0D; Sets the enable mode of single tone output.
OUT #0,%0P01; Sets an ineffective code into ROW register.
OUT #4,%0P02; Sets data "4" into COLUMN register

Example 2:8 bits data corresponding to the 5 bits of data linking the content of carry flag and the contents of data memory RAM1 address 90_H are read from the ROM, frequency selection codes are loaded into ROW and COLUMN registers, and dual tone is outputted.

LD HL, #90H; HL←90H (Sets the address of the data memory)

OUTB @HL ; Sets the ROM data into the ROW and COLUMN register.

Table 3-2 shows the corresponding frequency selection codes of the ROW and COLUMN registers for the telephone dial keys. Table 3-3 shows the deviation between the 47C858 tone output frequency and standard frequency.

		COLUM	N register (OP0	2 / IPO2)
	Frequency selection code	0001	0010 (1336)	0100
	0001 (697)	1	2	3
	0010 (770)	4	5	6
ROW register	0100 (852)	7	8	9
(OP01/IP01)	1000 (941)	•	0	#
		Standa	rd telephone d	ial key

Contents of () are standard frequencies, unit: Hz

Table 3-2. Corresponding frequency selection codes of the ROW and COLUMN registers for the telephone dial keys

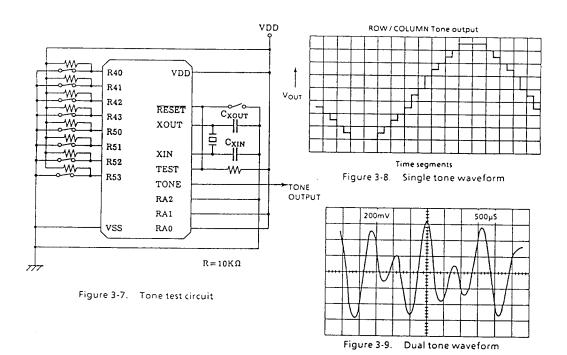
				ROW Tone		
Freque 3	ncy sel	ection 1	code 0	Tone output frequency [Hz]	Standard frequency [Hz]	Deviation [%]
0	0	0	1	697.7	697	+ 0.10
0	0	1	0	769.2	770	- 0.10
0	1	0	0	857.1	852	+ 0.60
1	0	0	0	937.5	941	- 0.37

				COLUMN Tone		
Freque	ncy sel	ection	code 0	Tone output frequency [Hz]	Standard frequency [Hz]	Deviation [%]
0	0	0	1	1212.1	1209	+ 0.26
0	0	1	0	1333.3	1336	- 0.20
0	1	0	0	1481.5	1477	+ 0.30
1	0	0	0	1621.6	1633	- 0.70

Table 3-3. Tone output frequencies and Deviation from standard

3.3.3 Test mode for tone output

The 47C85£ includes a test mode for checking tone output waveforms. Tones can be outputted by the curcuit shown in Figure 3-7. ROW data are inputted from the R4 port and COLUMN data are inputted from the R5 port, and any desired single or dual tones can be outputted by setting the frequency selection codes shown in Figure 3-6. Figure 3-8 shows a single tone waveform and Figure 3-9 shows a dual tone waveform.



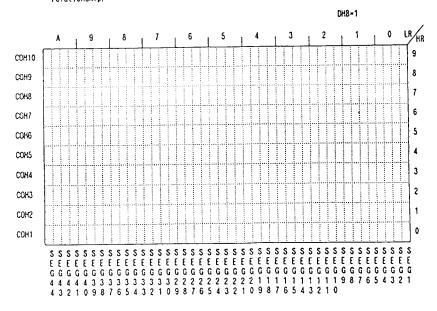
3.4 Display

3.4.1 Setting Display RAH

The data is stored in the display data area of RAM. Commands perform the processing which converts standard data into LCD display data (using mainly ROH data reference commands).

Display data is converted and stored in the area, and its data are automatically transfered to LCD drive circuit without any relation to program.

Each bit in the display data area of RAH and the LCD segment(dot) is in a one-to-one relationship.



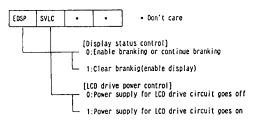
3.4.2 LCO Drive Control

There are 2-selecter circuit as LCD drive control. One is "Display status control", and the other is "LCD drive power control".

These code are selected by accessing the port resister address "OP1B".

(It is reset to "0" at initialization operation)

port resister address "OP18"



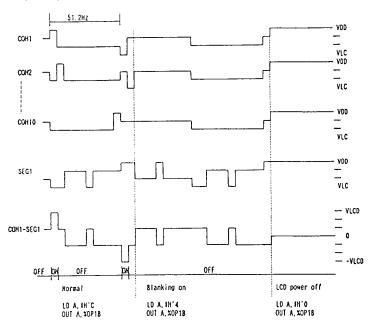
NOTE1:blanking-- COM1-COM10 goes into "non-light opration level". SEG1-SEG44 continues in normal operating status.

MOTE2: When the SVLC is "O", COH1-COH10 and SEG1-SEG44 go into VDD level.

Display output

Example of display output from the LCD drive circuit are given below.

(1/10 duty 1/3 bias)



Note: VLCD.VDD-VLC

TOSHIBA

ELECTRICAL CHARACTERISTICS

ABSOLUTE MAXIMUM RATINGS

 $(V_{SS} = 0V)$

PARAMETER	SYMBOL	PINS	RATINGS	UNIT
Supply Voltage	V _{DO}		- 0.3 to 7	V
Supply Voltage (LCD drive)	V _{LC}		- 0.3 to V _{DD} + 0.3	V
Input Voltage	V _{IN}		- 0.3 to V _{DD} + 0.3	V
Output Voltage	Vouti	Except sink open drain pin	- 0.3 to V _{DD} + 0.3	Ī
Output voitage	Voutz	Sink open drain pin	- 0.3 to 10	1 '
Output Current (Per 1 pin)	lout		3.2	mΑ
Power Dissipation [Topr = 70°C]	PD		600	mW
Soldering Temperature (time)	T _{sid}		260 (10sec)	•c
Storage Temperature	T _{stg}		- 55 to 125	•с
Operating Temperature	Topr		- 30 to 60	•c

RECOMMENDED OPERATING CONDITIONS

 $(V_{SS} = 0V, T_{opr} = -30 \text{ to } 60^{\circ}\text{C})$

PARAMETER	SYMBOL	PINS	CONDITIONS	Min.	Max.	דואט	
			In the Normal mode		2.7 6.0 2.0 0.7 0.75 V _{DD} 0.9 V _{DD} ×0.3 V _{DD} ×0.25 V _{DD} ×0.1 960		
Supply Voltage	V _{DD}		In the SLOW mode	2.7	6.0	V	
			in the SLEEPmode				
			In the HOLD mode	2.0	7		
	V _{IH1}	Except Hysteresis Input		V _{DD} × 0.7			
Input High Voltage	V _{IH2}	Hysteresis Input	V _{DD} ≥4.5V	V _{DD} × 0.75	V _{DD}	V _{DD}	V
	V _{IH3}		V _{DD} <4.5V	V _{DD} × 0.9			
	V _{IL1}	Except Hysteresis Input			V _{DD} × 0.3		
Input Low Voltage	V _{IL2}	Hysteresis Input	V _{DD} ≥4.5V	0	V _{DD} × 0.25	v	
	V _{IL3}		V _{DD} < 4.5V		V _{DD} × 0.1	7	
	fc	XIN, XOUT			960	KHz	
Clock Frequency	fs	XTIN, XTOUT		30.0	34.0	KHz	

D.C. CHARACTERISTICS

 $(V_{SS} = 0V, T_{opr} = -30 \text{ to } 60^{\circ}\text{C})$

PARAMETER	SYMBOL	PINS	CONDITIONS	Min.	Тур.	Max.	UNIT
Hysteresis Voltage	V _{HS}	Hysteresis Input		_	0.7	-	v
Input Current	I _{IN1}	Port KO, TEST, RESET, HOLD	V _{OD} = 5.5V,	_	_	± 2	
,	I _{IN2}	Open drain R port	V _{IN} = 5.5V / 0V			± 2	μА
Input Low Current	IIL	Push-pull R port	V _{DD} = 5.5V, V _{IN} = 0.4V	_	-	- 2	mA
Input Registance	R _{IN1}	Port K0 with pull-up/pull-down		30	70	150	
input Registance	R _{IN2}	RESET		100	220	450	ΚΩ
Output Leakage Current	ILO	Open drain ports P, R	V _{DD} = 5.5V, V _{OUT} = 5.5V	-	-	2	μА
Output High Voltage	Voн	Push-pull R port	V _{DD} = 4.5V, I _{OH} = -200μA	2.4	_	-	٧
Output Low Voltage	V _{OL2}	Except XOUT	V _{DD} = 4.5V, I _{OL} = 1.6mA	_	_	0.4	>
Segment Output Registance	Ros	SEG pin					
Common Output Registance	Roc	COM pin		-	20	-	ΚΩ
Segment/Common	VOZ/3		V _{DD} = 5V, V _{DD} - V _{LC} = 3V	3.8	4.0	4.2	
Output Voltage	Vois	SEG / COM pin		2.8	3.0	3.2	٧
Supply Current	loo		$V_{DD} = 5.5V, V_{LC} = V_{SS}$ fc = 960KHz	-	1.2	2.2	
(in the Nomal mode)	lopt		V _{DD} = 5.5V, V _{LC} = V _{SS} fc = 960KHz When tone is oscillating	-	3.0	5.0	mA
Supply Current (in the SLOW mode)	l _{DOS}		V _{DD} = 3V, V _{LC} = V _{SS}	-	30	60	
Supply Current (in the SLEEP: mode)	loosp		fs = 32.768KHz	-	15	25	μΑ
Supply Current (in the HOLD mode)	Гоон		V _{DD} = 5.5V	-	0.5	10	

- Note 1. Typ. values show those at $T_{opt} = 25^{\circ}\text{C}$, $V_{DD} = 5V$.
- Note 2. Input Current l_{IN1} ; The current through resistor is not included, when the input resistor (pull-up/pull-down) is contained.
- Note 3. Output Resistance Ros, Roc; Shows on-resistance at the level switching.
- Note 4. V_{O2/3}; Shows 2/3 level output voltage.
 - V_{O1/3}; Shows 1/3 level output voltage.
- Note 5. Supply Current I_{DD} ; $V_{IN} = 5.3V/0.2V$
 - The KO port is open when the input resistor is contained.
 - The voltage applied to the R port is within the valid range.
- Note 6. Supply Current IDDS; VIN = 2.8V/0.2V. Only low frequency clock is only osillated
 - (connecting XTIN, XTOUT).

A.C. CHARACTERISTICS

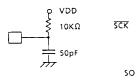
 $(V_{SS} = 0V, V_{DD} = 2.7 \text{ to } 6.0V, T_{opr} = -30 \text{ to } 60^{\circ}\text{C})$

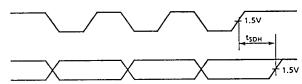
PARAMETER	SYMBOL	CONDITIONS	Min.	Тур.	Max.	UNIT
Lucia di a Curla Tirra		In the Normal mode	8.3	3		μs
Instruction Cycle Time	t _{cy}	In the SLOW mode	235		267	μs
High level Clock pulse Width	twcн	External clock	80	_	_	ns
Low level Clock pulse Width	twcL	External Clock				
Shift Data Hold Time	tson		0.5t _{cy} - 300	_	_	ns

Note. Shift Data Hold Time:

External Circuit for SCK pin and SO pin.

Serial port (completion of transmission)





TONE OUTPUT CHARACTERISTICS

 $(V_{SS} = 0V, V_{DD} = 2.7 \text{ to 6.0V}, T_{opr} = -30 \text{ to } 60^{\circ}\text{C})$

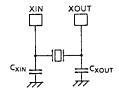
PARAMETER	SYMBOL	CONDITIONS	Min.	Тур.	Max.	TINU
Tone Output Voltage (ROW)	V _{TONE}	RL≥ 10KΩ, V _{DD} = 2.7V	125	185	250	m∨rms
Pre-emphasis High Band (COL/ROW)	PEHB	PEHB = 20log (COL/ROW)	1	2	3	d8
Output Distortion	DIS		T-	-	10	%
Frequency Stability	Δf	Except error of osc. frequency	-		0.7	%

RECOMMENDED OSCILLATING CONDITIONS

 $(V_{SS} = 0V, VDD = 2.7 \text{ to 6.0V}, Topr = -30 \text{ to 60°C})$

960KHz

Ceramic Resonator



(2) I/O Ports

The input/output circuitries of the 47C858 I/O ports are shown below, any one of the circuitries can be chosen by a code (WB, WE, WH) as a mask option.

PORT	I/O	INPUT/OUTPUT CIR	REMARKS	
K0	Input	R _{IN} ≱ R _{IN} ≱ R _{IN} R	Pull-up resistor $R_{IN} = 70K\Omega (typ.)$ $R = 1K\Omega (typ.)$	
R3 R4 R5 R6	VO.	Initial "Hi-Z"	WE, WH Initial "High" OVDD	Sink open drain or push-pull output R = 1KΩ (typ.)
R7 RA	1/0	WB, WE	Initial "High" OVDD	Sink open drain or push-pull output R = 1KΩ (typ.)
R8	I/O	——————————————————————————————————————	Sink open drain Initial "Hi-Z" Hysteresis input R = 1KΩ (typ.)	
R9	1/0	Initial "Hi-Z"	Initial "High"	Sink open drain or push-pull output Hysteresis input R = 1KΩ (typ.)

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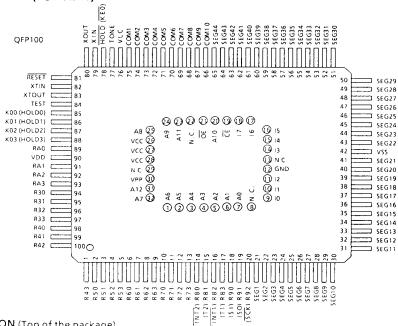
CMOS 4-BIT MICROCONTROLLER

TMP47C058G

The 47C058, which is equipped with an EPROM as program memory, is a piggyback type evaluator chip used for development and operational confirmation of the 47C858 application systems (programs).

The 47C058 is pin compatible with the 47C858 which is mask-programmed ROM device. The 47C058 which is equipped with an EPROM written the program operates like the 47C858.

PIN ASSIGNMENT (TOP VIEW)



PIN FUNCTION (Top of the package)

PIN NAME	Input / Output	FUNCTIONS	
A12 - A0	Output	Program memory address output	
17 - 10	Input	Program memory data input	
CE	Output	Chip enable signal output	
ŌĒ		Output enable signal output	
vcc	Power supply	+ 5V (connected with VDD)	
GND		0V (connected with VSS)	

A.C. CHARACTERISTICS

PARAMETER	SYMBOL	CONDITIONS	Min.	Тур.	Max.	UNIT
Address Delay Time	tad	$V_{SS} = 0V$, $V_{DO} = 2.7$ to 6.0V		-	150	ns
Data Setup Time	t _{IS}	C _L = 100 _{pF} Topr = -30 to 60 °C	150	-		ns
Data Hold Time	t _{IH}		50	-	-	ns

NOTES FOR USE

(1) Program memory

The program area depends on the capacity of EPROM. See Figure 1.

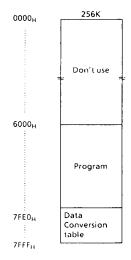


Figure 1. Program area

(2) I/O ports

Input/Output circuitries of I/O ports in the 47C058 are similar to the code WB of the 47C858. When this chip is used as evaluator with other I/O code (WE and WH), it is nacessary to provide the external resistors (See Figure 2).

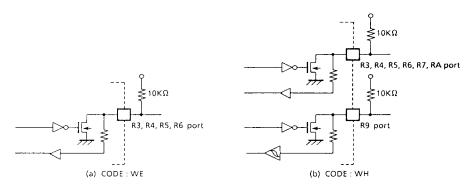


Figure 2. I/O code and external circuitry